





## UNITED STATES PATENT AND TRADEMARK OFFICE

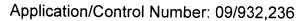
UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/932,236	08/16/2001	Haining Yang	MI22-1725	4828
21567	7590 04/10/2003	•		
WELLS ST. JOHN ROBERTS GREGORY & MATKIN P.S.			EXAMINER	
<b>SUITE 1300</b>	<del></del>		HOGANS, DAVID L	
SPOKANE, WA 99201-3828			ART UNIT	PAPER NUMBER
			2813	17
			DATE MAILED: 04/10/2003	12

Please find below and/or attached an Office communication concerning this application or proceeding.

Application No.   Applicant(s)	Jss				
Office Action Summary  Examiner  David L. Hogans  Th MAILING DATE of this communication appears on the cover sheet with th correspondence address of the cover sheet with the the	· ss				
David L. Hogans 2813  Th MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply	' ss				
Th MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply	' ss				
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A SHORTENED STATUTORY PERIOD FOR REPLY 13 SET TO EXPIRE 3 MONTH(3) FROM					
THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this comm.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).  - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).  Status	munication.				
1) Responsive to communication(s) filed on 30 January 2003.					
2a)⊠ This action is <b>FINAL</b> . 2b)  This action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. <b>Disposition of Claims</b>					
4) Claim(s) 2,4,13,14 and 42-47 is/are pending in the application.					
4a) Of the above claim(s) is/are withdrawn from consideration.					
5) Claim(s) is/are allowed.					
6)⊠ Claim(s) <u>2,4,13,14 and 42-47</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/or election requirement.					
Application Papers					
9) The specification is objected to by the Examiner.					
10)⊠ The drawing(s) filed on 16 August 2001 is/are: a)⊠ accepted or b)□ objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.					
If approved, corrected drawings are required in reply to this Office action.  12) The oath or declaration is objected to by the Examiner.					
Priority under 35 U.S.C. §§ 119 and 120					
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).					
a) ☐ All b) ☐ Some * c) ☐ None of:					
1. Certified copies of the priority documents have been received.					
2. Certified copies of the priority documents have been received in Application No					
3. Copies of the certified copies of the priority documents have been received in this National Stage					
application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.					
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).					
a) ☐ The translation of the foreign language provisional application has been received.  15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.					
Attachment(s)					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s) 6) Other:					





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#### **DETAILED ACTION**

This Office Action is in response to Amendment C filed on January 30, 2003.

### Status of Claims

Claims 2, 4, 13, 14 and 42-47 are pending. Claims 1, 3, 5-12 and 15-41 are cancelled.

# Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 2, 4 and 14 are rejected under 35 U.S.C. 103(a) as being unpatentable over 5,856,236 to Lai et al. in view of 6,211,034 to Visokay et al.

#### Claim 2

Lai et al. teaches: a semiconductor substrate (See column 3 lines 35-37); one or more metallo-organic precursors proximate the substrate wherein at least one does not comprise platinum (See columns 4-5 lines 55-20); exposing the precursor(s) to a reducing atmosphere (See column 4 lines 30-40); depositing the released metal over the substrate (See column 4 lines 10-15 and lines 30-40); wherein the substrate comprises an upper surface consisting of TiN and TaN and is also exposed to the reducing atmosphere (See column 4 lines 1-15 and lines 30-40).

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Lai et al. fails to explicitly teach patterning the metal containing mass into a rectangular block.

However, Visokay et al., in columns 6-7 lines 42-25 and Figures 2A-2G, teaches patterning Ruthenium, Iridium, Palladium or Rhodium, that has been deposited over Ti or TiN (see column 4 lines 1-10), into a rectangular block. Furthermore, Visokay et al. teaches one would pattern the metal containing mass to define a bottom electrode for use in sub-micron geometry DRAM devices.

It would have been obvious to one of ordinary skill in the art to modify Lai et al. by incorporating the patterning of Ruthenium, Iridium, Palladium or Rhodium into a rectangular block, as taught by Visokay et al., to define a bottom electrode for use in sub-micron geometry DRAM devices.

### Claim 4

Incorporating all arguments of Claim 2 and noting that Lai et al. teaches wherein the metal comprising mass is formed physically against the upper surface (See column 4 lines 10-15 and Figure 2).

### Claim 14

Incorporating all arguments of Claim 2 and noting that Lai et al. teaches wherein the reducing atmosphere comprises hydrogen (See column 4 lines 30-40).



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3. Claims 42-47 are rejected under 35 U.S.C. 103(a) as being unpatentable over 5,856,236 to Lai et al. in view of 6,211,034 to Visokay et al. further in view of Semiconductor Manufacturing Technology (2001) to Quirk et al.

### Claims 42-47

Incorporating all arguments of Claim 2 and noting that Lai et al., in column 4 lines 4-15, teaches depositing a metallo-organic metal over a titanium nitride or a tantalum nitride surface, but fails to explicitly teach wherein the upper surface is comprised by titanium, tantalum, tungsten or tungsten nitride. Furthermore, Visokay et al., in column 4 lines 1-10, teaches that Ruthenium, Iridium, Palladium and Rhodium can be deposited over titanium or titanium nitride.

However, Quirk et al., on pages 307-308, teaches that titanium, tantalum, tungsten and their nitrides are well known barrier metal layers within the art.

Furthermore, Quirk et al. teaches that these refractory metals and their nitrides prevent intermixing of the materials above and below the barrier (i.e. – they prevent material diffusion problems).

It would have been obvious to modify Lai et al. and Visokay et al. by incorporating tantalum, tungsten or tungsten nitride as a barrier metal, as taught by





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Quirk et al., to prevent intermixing of the materials above and below the barrier (i.e. – they prevent material diffusion problems).

4. Claim 13 is rejected under 35 U.S.C. 103(a) as being unpatentable over 5,856,236 to Lai et al. in view of 6,211,034 to Visokay et al. further in view of 5,907,789 to Komatsu.

Incorporating all arguments of Claim 2 and noting that Lai et al. and Visokay et al. fail to explicitly teach the deposition of a metallo-organic mass in a plasma activated hydrogen atmosphere.

However, Komatsu, in columns 21-22 lines 64-29, teaches the deposition of rhodium, iridium, cobalt, palladium or nickel by a plasma activated hydrogen (i.e. – a microwave power of 2.0 kW). Furthermore, Komatsu teaches that this layer forms a low resistance plug or interconnect.

It would have been obvious to one of ordinary skill in the art to modify Lai et al. and Visokay et al. by incorporating the deposition of rhodium, iridium, cobalt, palladium or nickel by a plasma activated hydrogen (i.e. – a microwave power of 2.0 kW), as taught by Komatsu, to form a low resistance contact or plug.





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## Response to Arguments

Applicant's argument with respect to Claim 2 has been considered but is moot in view of the new ground(s) of rejection.

#### Conclusion

5. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to David L. Hogans whose telephone number is (703) 305-3361. The examiner can normally be reached on M-F (7:30-4:30).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead Jr. can be reached on (703) 308-4940. The fax phone





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numbers for the organization where this application or proceeding is assigned are (703) 308-7722 for regular communications and (703) 308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-1782.

dh April 2, 2003

CARL WHITEHEAD JR.
SUPERVISORY PATENT EXAMINER
TECHNOLOGY CENTER 2800